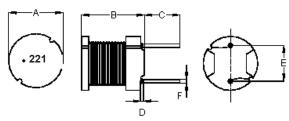
# Inductor Radial Leaded

### multicomp PRO





#### **Configurations and Dimensions**



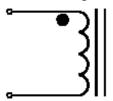
**Top View** 

**Front View** 

**Bottom View** 

Note: White dot of marking indicates the start terminal of winding

#### **Schematic Diagram**



#### Note:

- 1. Wire UEFN/U (155°C) Ø0.3mm
- 2. 83.5TS (Reference) C.W

#### **Test Data for Mechanical**

Test Item	A mm	B mm	C mm	D mm	E mm	F mm
Specification	7.8 ±0.5	9.5 ±0.5	5 ±1	3 (Max.)	5 ±0.5	Ø0.7 (Ref.)
1	7.8	9.49	5.17	1.38	4.99	0.69
2	7.81	9.47	5.18	1.27	5.1	0.68
3	7.82	9.45	5.12	1.38	4.92	0.7
4	7.8	9.47	5.11	1.44	F 44	0.69
5	7.81	9.48	5.34	1.25	5.11	0.68
Average	7.81	9.47	5.18	1.34	5.05	0.69

#### **Electrical Characteristics**

Test Condition		
1kHz 0.25V	L	220μH ±10%
T <sub>A</sub> = 25°C	DCR	480mΩ (Max)
1kHz 0.25 V Irms = 0.64A	ΔΤ	Temperature rise 40°C (Max.)

Operating temperature : -55°C to +130°C

#### **Material List**

No.	Item	Material Description		
1	Core	F6D DR2W7.8 × 9.5 (SW) RCH B3.6 F5.4 P5		
2	Wire	Ø0.3mm UEFN/U (155°C)		
3	Solder (Lead-free)	Sn99.3% / Cu0.7%		

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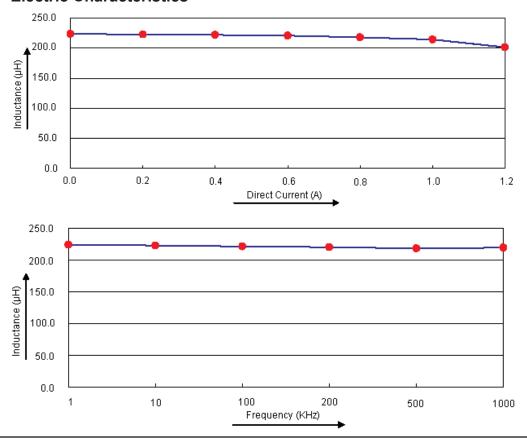
### Inductor Radial Leaded



#### **Reliability Test**

Test Item	Specifications		Test Method and Remarks		
Operating temperature range	-55°C to +130°C		Including temperature r	ise due to self-generated heat.	
Storage condition	Ambient temperature : 0°C to 40°C Humidity : Below 70% RH		To maintain the solderability of terminal electrodes, care must be taken to control temperature and humidity in the storage area.		
Moisture sensitivity	Appearance  DCR change Inductance change	: No abnormality No damage : Within ±5% : Within ±5%	According to J-STD-02 Test condition Test duration Recovery	OB level 3 : 60°C 60% RH : 40 hrs : 1 to 2 hours of recovery under the standard condition after the removal from the test chamber.	
Solderability	All termination shall exhibit a continuous solder coating free from defects for a minimum of 95% of the surface area of any individual lead.		According to J-STD-00. Steam aging category Steam aging duration Solder Solder temperature Dip time	: 97°C 98% RH	

#### **Electric Characteristics**



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## Inductor Radial Leaded



#### **Test Data for Electrical**

Test Item	L µH	DCR Ω	ΔΤ
Condition	1kHz 0.25V	at 25°C	1kHz 0.25V Irms = 0.64A
Specification	220 ±10%	480 (Max.)	Temperature rise 40°C (Max.)
1	219.78	420.3	
2	219.15	419.8	
3	218.64	417.5	OK
4	218.26	418.9	
5	219.26	418.5	
Average	219.02	419	OK

#### **Part Number Table**

Description	Part Number	
Inductor, 220µH, 10%, Radial Leaded	MCSCH895-221KU	

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